

ON Semiconductor®

FDS8984-F085 N-Channel PowerTrench[®] MOSFET 30V, 7A, 23mΩ

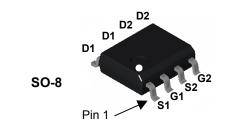
General Description

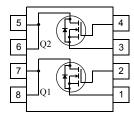
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(ON)}$ and fast switching speed.



Features

- Max r_{DS(on)} = 23mΩ, V_{GS} = 10V, I_D = 7A
- Max r_{DS(on)} = 30mΩ, V_{GS} = 4.5V, I_D = 6A
- Low gate charge
- 100% R_G tested
- Qualified to AEC Q101
- RoHS Compliant





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS}	Drain to Source Voltage		30	V
V _{GS}	Gate to Source Voltage		±20	V
	Drain Current Continuous	(Note 1a)	7	Α
ID	Pulsed		30	А
E _{AS}	Single Pulse Avalache Energy	(Note 2)	32	mJ
	Power Dissipation for Single Operation		1.6	W
P _D	Derate above 25°C		13	mW/°C
T _J , T _{STG}	Operating and Storage Temperature		-55 to 150	°C
Therma	Characteristics			
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
Raic	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

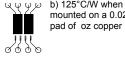
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS8984	FDS8984-F085	SO-8	330mm	12mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	30			V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		23		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24V$ $V_{GS} = 0V$ $T_J = 125^{\circ}C$			1 250	μA	
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V			±100	nA	
)n Chara	cteristics (Note 3)						
	Gate to Source Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	1.2	1.7	2.5	V	
$V_{GS(th)} \over \Delta V_{GS(th)} \over \Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C	1.2	- 4.3	2.5	mV/°C	
<u> </u>	Drain to Source On Resistance	V _{GS} = 10V, I _D = 7A		19	23	-	
_		$V_{GS} = 4.5V, I_D = 6A$		24	30	-	
r _{DS(on)}		$V_{GS} = 10V, I_D = 7A, T_J = 125^{\circ}C$		26	32	mΩ	
C _{iss}	Input Capacitance	V _{DS} = 15V, V _{GS} = 0V,		475	635	pF	
C _{oss}	Output Capacitance Reverse Transfer Capacitance	f = 1.0 MHz		100 65	135 100	pF pF	
C _{oss} C _{rss} R _G						•	
C _{oss} C _{rss} R _G	Reverse Transfer Capacitance	f = 1.0MHz		65	100	pF	
C _{oss} C _{rss} R _G Switchinç	Reverse Transfer Capacitance Gate Resistance	f = 1.0MHz		65	100	pF	
C _{oss} C _{rss} R _G Switching	Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time Rise Time	f = 1.0MHz f = 1MHz V _{DD} = 15V, I _D = 7A		65 0.9	100 1.6	pF Ω	
C _{oss} C _{rss} R _G Switchinç t _{d(on)} t _r	Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time	f = 1.0MHz f = 1MHz		65 0.9 5	100 1.6 10	pF Ω ns	
C _{oss} C _{rss} R _G Switching t _{d(on)} t _r	Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time Rise Time	f = 1.0MHz f = 1MHz $V_{DD} = 15V, I_D = 7A$ $V_{GS} = 10V, R_{GS} = 33Ω$		65 0.9 5 9	100 1.6 10 18	pF Ω ns ns	
$\begin{array}{c} C_{oss} \\ \hline C_{rss} \\ \hline R_G \\ \hline \textbf{Switching} \\ \hline \textbf{Switching} \\ \hline \textbf{t}_{d(on)} \\ \hline \textbf{t}_r \\ \hline \textbf{t}_{d(off)} \\ \hline \textbf{t}_f \\ \hline \textbf{Q}_g \end{array}$	Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time Rise Time Turn-Off Delay Time	f = 1.0MHz f = 1MHz V _{DD} = 15V, I _D = 7A		65 0.9 5 9 42 21 9.2	100 1.6 10 18 68 34 13	pF Ω ns ns ns	
C _{oss} C _{rss} R _G Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g	Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$f = 1.0MHz$ $f = 1MHz$ $V_{DD} = 15V, I_D = 7A$ $V_{GS} = 10V, R_{GS} = 33\Omega$ $V_{DS} = 15V, V_{GS} = 10V,$		65 0.9 5 9 42 21	100 1.6 10 18 68 34	pF Ω ns ns ns ns	
C _{oss} C _{rss} R _G	Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$f = 1.0MHz$ $f = 1MHz$ $V_{DD} = 15V, I_D = 7A$ $V_{GS} = 10V, R_{GS} = 33\Omega$ $V_{DS} = 15V, V_{GS} = 10V,$ $I_D = 7A$		65 0.9 5 9 42 21 9.2 5.0 1.5	100 1.6 10 18 68 34 13	pF Ω ns ns ns nc nC nC	
C _{oss} C _{rss} R _G Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs}	Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$f = 1.0MHz$ $f = 1MHz$ $V_{DD} = 15V, I_D = 7A$ $V_{GS} = 10V, R_{GS} = 33\Omega$ $V_{DS} = 15V, V_{GS} = 10V,$ $I_D = 7A$ $V_{DS} = 15V, V_{GS} = 5V,$		65 0.9 5 9 42 21 9.2 5.0	100 1.6 10 18 68 34 13	pF Ω ns ns ns nc nC	
C _{oss} C _{rss} R _G Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge	$f = 1.0MHz$ $f = 1MHz$ $V_{DD} = 15V, I_D = 7A$ $V_{GS} = 10V, R_{GS} = 33\Omega$ $V_{DS} = 15V, V_{GS} = 10V,$ $I_D = 7A$ $V_{DS} = 15V, V_{GS} = 5V,$		65 0.9 5 9 42 21 9.2 5.0 1.5	100 1.6 10 18 68 34 13	pF Ω ns ns ns nc nC nC	
C _{oss} C _{rss} R _G Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _g Q _g Q _{gd} Drain-Sou	Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge	$f = 1.0MHz$ $f = 1MHz$ $V_{DD} = 15V, I_D = 7A$ $V_{GS} = 10V, R_{GS} = 33\Omega$ $V_{DS} = 15V, V_{GS} = 10V,$ $I_D = 7A$ $V_{DS} = 15V, V_{GS} = 5V,$ $I_D = 7A$		65 0.9 5 9 42 21 9.2 5.0 1.5	100 1.6 10 18 68 34 13	pF Ω ns ns ns nc nC nC	
C _{oss} C _{rss} R _G Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gg} Q _{gg} Q _{gd} Drain-Sou	Reverse Transfer Capacitance Gate Resistance J Characteristics (Note 3) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics Source to Drain Diode Voltage	$f = 1.0MHz$ $f = 1MHz$ $V_{DD} = 15V, I_D = 7A$ $V_{GS} = 10V, R_{GS} = 33\Omega$ $V_{DS} = 15V, V_{GS} = 10V,$ $I_D = 7A$ $V_{DS} = 15V, V_{GS} = 5V,$ $I_D = 7A$		65 0.9 5 9 42 21 9.2 5.0 1.5 2.0	100 1.6 10 18 68 34 13 7	pF Ω ns ns ns nC nC nC	
$\begin{array}{c} C_{oss} \\ \hline C_{rss} \\ \hline R_{G} \\ \hline \textbf{Switching} \\ \hline \textbf{Switching} \\ \hline \textbf{t}_{d(on)} \\ \hline \textbf{t}_{r} \\ \hline \textbf{t}_{d(off)} \\ \hline \textbf{t}_{f} \\ \hline \textbf{Q}_{g} \\ \hline \textbf{Q}_{g} \\ \hline \textbf{Q}_{gs} \\ \hline \textbf{Q}_{gd} \\ \hline \end{array}$	Reverse Transfer Capacitance Gate Resistance Characteristics (Note 3) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge	$f = 1.0MHz$ $f = 1MHz$ $V_{DD} = 15V, I_D = 7A$ $V_{GS} = 10V, R_{GS} = 33\Omega$ $V_{DS} = 15V, V_{GS} = 10V,$ $I_D = 7A$ $V_{DS} = 15V, V_{GS} = 5V,$ $I_D = 7A$		65 0.9 5 9 42 21 9.2 5.0 1.5 2.0	100 1.6 10 18 68 34 13 7 1.25	pF Ω ns ns ns nC nC nC vV	



pad of 2 oz copper

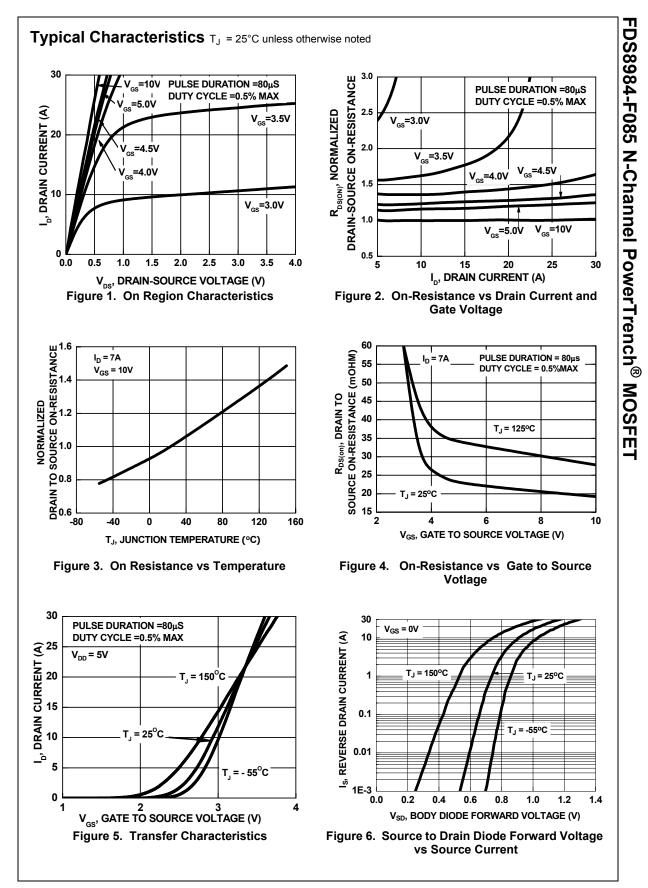


minimun pad

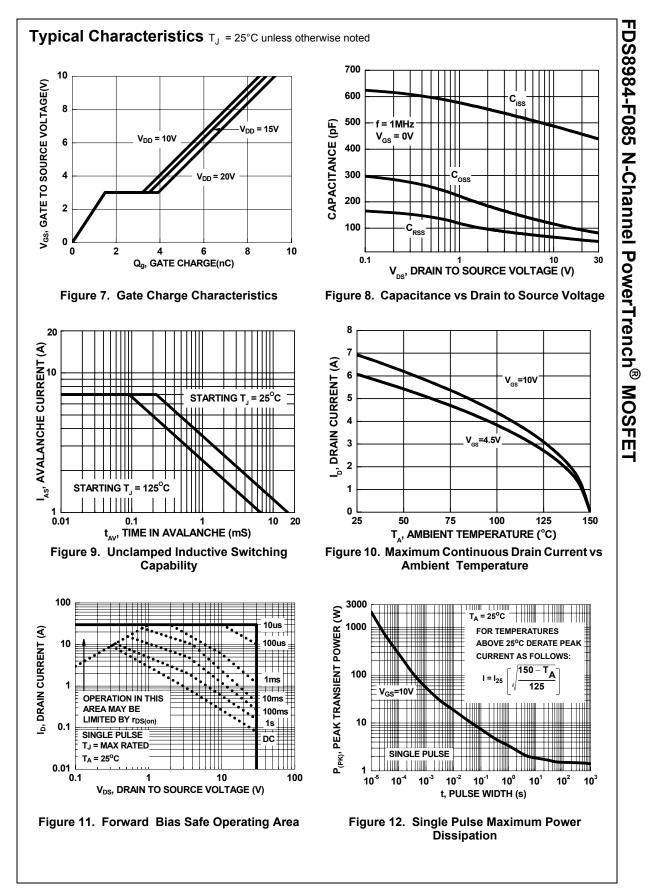
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Scale 1 : 1 on letter size paper

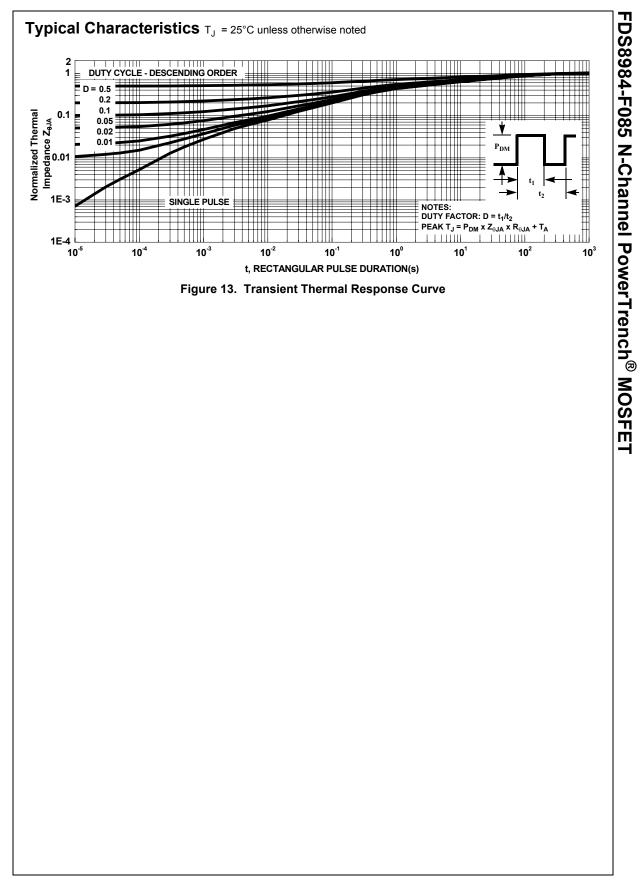
2: Starting  $T_J$  = 25°C, L = 1mH,  $I_{AS}$  = 8A,  $V_{DD}$  = 27V,  $V_{GS}$  = 10V. 3: Pulse Test:Pulse Width <300 $\mu$ S, Duty Cycle <2%.



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